

32 N Gould St., Sheridan, WY 82801, USA

Tel.: +1 (786) 825 8645 Email: sales@thinfilmmaterials.com WhatsApp: Keyue Advanced Materials Website: www.thinfilmmaterials.com

Certificate of Analysis (CoA)

July 14, 2025

Product Name: Indium Sputtering Target

Chemical Formula: In Purity: ≥99.99% (4N)

Dimensions: \emptyset 50.8 mm × 6.35 mm (2" × 1/4")

Backing Plate: Indium bonded to 3 mm thick Titanium plate with keeper

Lot Number: XKCS-25-SC-3958

Physical Description

• Form: Metallic sputtering target

Appearance: Silvery-white, soft metallic surface

Crystal Structure: Tetragonal

Density: ~7.31 g/cm³

• Fabrication: Bonded using high-purity indium bonding layer to Ti

backing plate

Features: Mechanical keeper included

Theoretical Composition

• **Element**: Indium (In)

• Atomic Weight: 114.82 g/mol

• Mass Fraction: 100% In (elemental metal)

Chemical Composition (by ICP-OES)

Element	Symbol	Max. Content (ppm)
Indium	In	Balance (>99.99%)
Lead	Pb	<10
Tin	Sn	<10
Zinc	Zn	<5
Cadmium	Cd	<5
Iron	Fe	<5



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Element	Symbol Max. Content	(ppm)
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Other trace elements (each) – <5

Total Impurities – <100 ppm

Handling & Storage

- Indium is soft and malleable; avoid scratching or denting the surface.
- Store in vacuum-sealed or inert atmosphere packaging.
- Avoid high temperatures that may cause deformation of pure indium or bonding layer.

Declaration

We hereby certify that the above product has been manufactured and tested in accordance with our quality control procedures and meets the specifications stated herein.

Inspection Certificate by:	Nancy Liu	
Approver by:	Chen Qiang	chen Gang